

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHAMP TECH OPTICAL (FOSHAN) CORPORATION	02/08/2017
Foxconn Technology Co., Ltd.	02/08/2017
RECEIVING PARTY DATA	
Name:	CHAMP TECH OPTICAL (FOSHAN) CORPORATION
Street Address:	No.35, Huabao North Road, Chengxi Industrial Zone,Chancheng District
City:	Foshan
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	8932014
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DATE SIGNED:	02/28/2017
Total Attachments: 5	
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ASSIGNMENT OF U.S. PATENTS

WHEREAS, CHAMP TECH OPTICAL (FOSHAN) CORPORATION, (hereinafter CHAMP) of No.35, Huabao North Road, Chengxi Industrial Zone, Chancheng District, Foshan, Guangdong, China, and WHEREAS, Foxconn Technology Co., Ltd. (hereinafter Foxconn) of 3-2, Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C. are the owner of the U.S. patents listed below by virtue of assignments recorded in the United States Patent and Trademark Office, also as listed below.

Assignment recorded		
<u>Application No.</u>	<u>Application Date</u>	<u>Case name</u>
11/135170	23-May-05	FRAME FOR AN ELECTRICAL FAN
11/308704	24-Apr-06	HEAT DISSIPATION DEVICE
11/164167	13-Nov-05	HEAT SINK WITH HEAT PIPES
11/306412	27-Dec-05	HEAT DISSIPATION DEVICE
11/308555	06-Apr-06	FAN FASTENER FOR FASTENING A FAN TO A HEAT SINK AND METHOD OF USING THE SAME
11/308385	20-Mar-06	HEAT DISSIPATION DEVICE WITH HEAT PIPE
11/308705	24-Apr-06	HEAT SINK CLIP AND ASSEMBLY
11/307109	24-Jan-06	VIDEO GRAPHICS ARRAY (VGA) CARD ASSEMBLY
11/308384	20-Mar-06	HEAT DISSIPATING DEVICE HAVING A FIN ALSO FUNCTIONING AS A FAN DUCT
11/564265	28-Nov-06	HEAT DISSIPATION DEVICE WITH HEAT PIPES
11/309344	28-Jul-06	HEAT DISSIPATION DEVICE
11/308250	14-Mar-06	HEAT DISSIPATION DEVICE HAVING A BRACKET
11/244916	05-Oct-05	HEAT SINK ASSEMBLY
11/163902	03-Nov-05	GREASE PROTECTING APPARATUS FOR HEAT SINK
11/306357	25-Dec-05	HEAT DISSIPATION DEVICE
11/308598	10-Apr-06	THERMAL MODULE
11/556533	03-Nov-06	HEAT-PIPE TYPE HEAT SINK
11/308774	02-May-06	COOLING FAN
11/309305	24-Jul-06	HEAT DISSIPATION DEVICE WITH HEAT PIPES
11/566003	01-Dec-06	HEAT DISSIPATION DEVICE WITH HEAT PIPES
11/626159	23-Jan-07	HEAT DISSIPATION DEVICE WITH MULTIPLE HEAT PIPES
11/695448	02-Apr-07	MOUNTING STRUCTURE FOR A STATOR OF A MOTOR
11/752905	23-May-07	HEAT DISSIPATION DEVICE WITH HEAT PIPES

11/742724	01-May-07	MOUNTING STRUCTURE FOR A STATOR OF A MOTOR-STATOR
11/695456	02-Apr-07	FAN BRACKET AND HEAT DISSIPATION APPARATUS INCORPORATING THE SAME
11/690046	22-Mar-07	HEAT DISSIPATION DEVICE HAVING A FIXING BASE
11/777034	12-Jul-07	HEAT DISSIPATION DEVICE WITH HEAT PIPES
11/772810	02-Jul-07	HEAT DISSIPATION DEVICE WITH HEAT PIPES
11/778545	16-Jul-07	COOLING FAN WITH BALANCE STRUCTURE
11/767032	22-Jun-07	HEAT DISSIPATION DEVICE HAVING A FAN FOR DISSIPATING HEAT GENERATED BY AT LEAST TWO ELECTRONIC COMPONENTS
11/831930	31-Jul-07	HEAT SINK ASSEMBLY WITH A LOCKING DEVICE
11/776862	12-Jul-07	HEAT DISSIPATION DEVICE
11/842908	21-Aug-07	BUFFER STRUCTURE FOR HEAT DISSIPATING FAN
11/836715	09-Aug-07	HEAT DISSIPATION DEVICE
11/854479	12-Sep-07	FAN ROTOR
11/836712	09-Aug-07	HEAT DISSIPATION DEVICE
11/946452	28-Nov-07	COOLING FAN WITH BALANCE STRUCTURE
11/850824	06-Sep-07	HEAT SINK HAVING PROTECTIVE DEVICE FOR THERMAL INTERFACE MATERIAL SPREAD THEREON
11/955297	12-Dec-07	COOLING FAN
11/964790	27-Dec-07	COOLING FAN
11/861680	26-Sep-07	HEAT DISSIPATION DEVICE WITH A HEAT PIPE
11/926701	29-Oct-07	HEAT DISSIPATION DEVICE WITH U-SHAPED AND S-SHAPED HEAT PIPES
11/957341	14-Dec-07	FAN FRAME
11/961313	20-Dec-07	FAN MOTOR WITH MOUNTING STRUCTURE
11/959280	18-Dec-07	COOLING FAN
11/964899	27-Dec-07	HEAT DISSIPATION DEVICE HAVING A FAN HOLDER
11/961375	20-Dec-07	HEAT DISSIPATION DEVICE HAVING A FAN HOLDER FOR ATTACHMENT OF A FAN
11/964919	27-Dec-07	HEAT SINK WITH HEAT PIPES
12/051857	20-Mar-08	HEAT SINK ASSEMBLY HAVING A CLIP
12/056295	27-Mar-08	HEAT DISSIPATION DEVICE WITH HEAT PIPE
12/056298	27-Mar-08	HEAT SINK ASSEMBLY AND METHOD FOR MANUFACTURING THE SAME

12/248004	08-Oct-08	HEAT DISSIPATION DEVICE
12/168910	08-Jul-08	FAN FRAME AND HEAT DISSIPATION FAN INCORPORATING THE FAN FRAME
12/115516	05-May-08	CLIP FOR HEAT SINK
12/202396	01-Sep-08	COOLING FAN
12/195398	20-Aug-08	COOLING FAN
12/252373	16-Oct-08	HEAT SINK AND METHOD OF MANUFACTURING THE SAME
12/331390	09-Dec-08	HEAT DISSIPATION APPARATUS HAVING HEAT PIPES INSERTED THEREIN
12/488524	20-Jun-09	HEAT DISSIPATION FAN
12/488525	20-Jun-09	THERMAL MODULE
12/329611	07-Dec-08	HEAT SINK ASSEMBLY HAVING HEAT PIPE
12/500615	10-Jul-09	HEAT DISSIPATION DEVICE AND METHOD FOR MANUFACTURING THE SAME
12/506213	20-Jul-09	HEAT SINK AND METHOD OF MANUFACTURING THE SAME
12/508582	24-Jul-09	HEAT DISSIPATION DEVICE
12/537265	07-Aug-09	HEAT DISSIPATION DEVICE FOR MEMORY MODULE
12/565771	24-Sep-09	HEAT DISSIPATION DEVICE
12/537267	07-Aug-09	METHOD OF MANUFACTURING HEAT SINK
12/565712	23-Sep-09	HEAT DISSIPATION DEVICE
12/547446	25-Aug-09	FAN ASSEMBLY
12/641340	18-Dec-09	HEAT DISSIPATION DEVICE
12/620500	17-Nov-09	HEAT DISSIPATION DEVICE WITH MULTIPLE HEAT SINKS
12/626683	27-Nov-09	SLEEVE BEARING SYSTEM
12/697305	01-Feb-10	COOLING FAN
12/915009	29-Oct-10	HEAT SINK ASSEMBLY
12/758740	12-Apr-10	THERMAL MODULE
12/770783	30-Apr-10	HEAT DISSIPATION DEVICE AND CENTRIFUGAL FAN THEREOF
12/827059	30-Jun-10	CENTRIFUGAL FAN
13/329329	19-Dec-11	COOLING FAN
13/236615	19-Sep-11	HEAT DISSIPATION FAN WITH MAGNET RING OF VARYING THICKNESS
13/278099	20-Oct-11	HEAT DISSIPATION FAN AND STATOR THEREOF

13/271162	11-Oct-11	HEAT DISSIPATION APPARATUS WITH HEAT PIPE
13/241174	22-Sep-11	FAN ASSEMBLY
13/650499	12-Oct-12	METHOD FOR MANUFACTURING A HEAT SINK
14/014393	30-Aug-13	WIRELESS CHARGING DEVICE
14/049225	09-Oct-13	WIRELESS CHARGING DEVICE
14/080770	14-Nov-13	CHARGING BATTERY UNIT AND ELECTRONIC DEVICE WITH THE SAME
14/526146	28-Oct-14	COVER OF A HANDHELD ELECTRONIC DEVICE
14/806860	23-Jul-15	FAN ASSEMBLY
14/833592	24-Aug-15	LIGHT EMITTING DIODE STREET LAMP CONTROL SYSTEM
14/738051	12-Jun-15	HEAT DISSIPATION FAN
14/614595	05-Feb-15	LED ILLUMINATION DEVICE HAVING A HEAT SINK WITH A PLURALITY OF SETS OF FINS DEFINING AIR TUNNELS OF DIFFERENT SIZES
14/861633	22-Sep-15	STREET LAMP
14/867613	28-Sep-15	VAPOR CHAMBER
14/880665	12-Oct-15	LIGHT EMITTING DIODE MODULE
14/847844	08-Sep-15	LIGHT EMITTING DIODE (LED) LAMP
15/218288	25-Jul-16	FAN FRAME AND HEAT DISSIPATION FAN HAVING THE SAME

WHEREAS, CHAMP TECH OPTICAL (FOSHAN) CORPORATION (hereinafter CHAMP) of No.35, Huabao North Road, Chengxi Industrial Zone,Chancheng District,Foshan, Guangdong, China is desirous of acquiring the above identified U.S. patents to be obtained therefrom.

Therefore, in consideration of One Dollar (\$1.00) and other good and valuable considerations, the receipt of which is hereby acknowledged, CHAMP and Foxconn hereby sell, assign and transfer to CHAMP, their successors and assigns, 100% of the entire right, title and interest in the U.S. patents listed above and any divisions or continuations thereof, and any reissues or extensions of the U.S. patents.

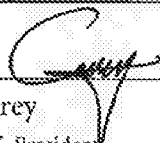
CHAMP and Foxconn hereby covenants that it has full right to convey 100% of the entire right, title and interest in the U.S. patents listed above, and has not executed and will not execute any agreement in conflict herewith.

CHAMP and Foxconn further covenants that it will, at any time, upon request, execute and deliver any and all papers that may be necessary or desirable to perfect the title in CHAMP to the U.S. patents listed above, and if CHAMP, or its assignee, desire to claim priority under the International Convention, make a substitute, divisional or continuation application, or to secure a reissue or extension of a U.S. patent, or to file a disclaimer relating thereto, that it will upon request, sign all papers, make all rightful oaths and declarations, and do all lawful acts requisite

for the such purposes.

Executed and delivered this 8 day of 2, 2017

CHAMP TECH OPTICAL (FOSHAN) CORPORATION.

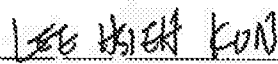
By: 

Name: Carey

Title : President

Executed and delivered this 8 day of 2, 2017

Foxconn Technology Co., Ltd.

By: 

Name: LEE HSIEH KON

Title : President